Filenam	e: PMP7009REVA_B	ILLOFMATERIA	LS_bom.xls			
Date: 09	)/08/2011					
		<b>PMP7009</b>	REVA_BILLOFMATERIALS BO	MC		
COUNT		Value	Description	Size	Part Number	MFR
1	C1	270pF	Capacitor, Ceramic, 50V, [temp], [tol]	0603	std	std
1	C2	220nF	Capacitor, Ceramic, 16V, [temp], [tol]	0603	std	std
1	C3	150pF	Capacitor, Ceramic, 50V, [temp], [tol]	0603	std	std
1	C4	22nF	Capacitor, Ceramic, 50V, [temp], [tol]	0603	std	std
1	C5	1u	Capacitor, Ceramic, 50V	0805	Std	Std
1	C7	1uF	Capacitor, Ceramic, 16V, X7R, 20%	0603	std	std
1	C9	270pF	Capacitor, Ceramic, vvV, [temp], [tol]	0603	std	std
1	C27	330uF	Capacitor, Electrolytic, SMT, 330uF, 35Vdc	0.457 x 0.406	EEEVFK1V331P	Panasonic
2	C13-14	330uF	Capacitor, Aluminum Electrolytic, 25V, ±20%	0.328 x 0.390 inch	EEEFK1E3311P	Panasonic
6	C8 C10-12 C15 C28	10uF	Capacitor, Ceramic, X7R, 25V	1210	C3225X7R1E106M	TDK
1	D1	B560C	Diode, 5A, 60V	SMC	B560C	Diodes Inc.
1	D3	6.8V	Diode, Zener, 6.8V	SOD-323	MMSZ5235BS-7-F	Diodes
1	D4	4.7V	Diode, Zener, 4.7V	SOD-323	MMSZ5230BT1	Diodes
2	J1-2	D120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35 inch	D120/2DS	OST
1	L2	22uH	Inductor, SMT Dual Winding, 3.78A, 79milliohm	0.492 x 0.492 inch	DRQ127-220R	Cooper
1	Q2	MMBT2222A	Bipolar, NPN, 40V, 600mA	SOT23	MMBT2222ALT1	On Semi
1	Q3	Si7850DP	MOSFET, NChannel, 60V, 10.3 A, 0.022 millohm	PWRPAK S0-8	Si7850DP	Vishay
1	R1	205k	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R2	100k	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R3	2.55k	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R5	49.9k	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R8	100k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R9	49.9	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R10	1k	Resistor, Chip, 1/16W, 1%	0603	std	std
1	R11	0.025	Resistor, Chip, 1/2W, 1%	1812	Std	Std
1	R17	237k	Resistor, Chip, 1/16W, 1%	0805	Std	Std
2	R16 R18	20k	Resistor, Chip, 1/16W, 1%	0805	Std	Std
2	R6-7	4.7	Resistor, Chip, 1/16W, 1%	0603	std	std

1	TP7	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
3	TP1 TP8 TP11	5011	Test Point, Black, Thru Hole	0.125 x 0.125 inch	5011	Keystone
2	TP2 TP10	5010	Test Point, Red, Thru Hole	0.125 x 0.125 inch	5010	Keystone
2	TP4-5	5002	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	U1	TPS40210DGS	IC, Low Cost Non-Synchronous Boost Controller	DGS10	TPS40210DGS	TI
Notes:	1. These assemblie	s are ESD sensit	ive, ESD precautions shall be observed.			
	2. These assemblie	s must be clean				
	Use of no clean f	lux is not accepta				
	3. These assemblie	s must comply w				
	4. Ref designators r	narked with an a				
	All other compone	ents can be subs				

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